ABSTRACT OF THE DISCLOSURE

A transporting device for a vertical-type thin circuit board etching machine which includes a base plate, a plurality of transporting units erected in linear formation and spaced apart on a base plate, a transmission shaft, characterized in that the transmission shaft passes through the other end of the frame connection of a plurality of transmission unit modules, and one end of the transmission shaft is connected to a power source and at the connection transmission unit, worm gears are formed, and for the transmission unit module includes transmission clip rollers, mounted in series to the shaft upward the base plate and mounted at the two lateral sides of the worm gears, a plurality of support rollers, a support roller frame driving gears, and the two driving gears are engaged with the corresponding worm gears, and the gap between two support roller faces of the support roller frames are stacked and the gap is the cleansing-etching thickness of the circuit board, and the base plate which corresponds to a circuit board portion is made of an etching resistant rigid material.